

DATA SHEET

BLV58

UHF linear push-pull power
transistor

Product specification

September 1991

UHF linear push-pull power transistor

BLV58

FEATURES

- High power gain
- Double stage internal input matching for high input impedance
- Diffused emitter-ballasting resistors enhances ruggedness
- Gold metallization for high reliability.

DESCRIPTION

The BLV58 is a common emitter epitaxial npn silicon planar transistor designed for high linearity class-A operation in UHF (bands 4 and 5) TV transmitters and transposers.

The device is incorporated in a push-pull SOT289 flange envelope with a ceramic cap, which is utilized with the emitters connected to the flange.

PINNING - SOT289

PIN	DESCRIPTION
1	collector 1
2	collector 2
3	base 1
4	base 2
5	emitter

QUICK REFERENCE DATA

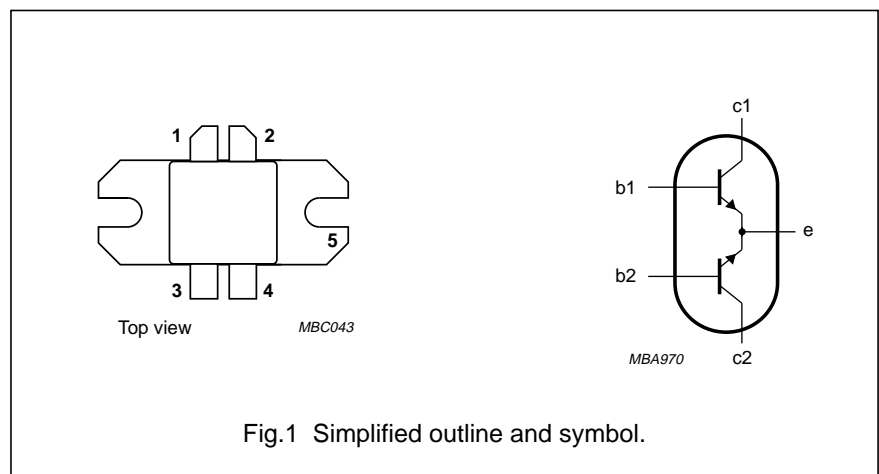
RF performance at $T_h = 25\text{ }^\circ\text{C}$ in a common emitter test circuit.

MODE OF OPERATION	f_{vision} (MHz)	V_{CE} (V)	I_{CQ} (A)	$P_{\text{o sync}}$ (W)	G_p (dB)	d_{im} (dB) (note 1)
c.w. class-A	860	25	2×1.6	25	>10	< -45

Note

1. Three-tone test method (vision carrier -8 dB, sound carrier -7 dB, sideband signal -16 dB); zero dB corresponds to peak sync level.

PIN CONFIGURATION



WARNING

Product and environmental safety - toxic materials

This product contains beryllium oxide. The product is entirely safe provided that the BeO discs are not damaged. All persons who handle, use or dispose of this product should be aware of its nature and of the necessary safety precautions. After use, dispose of as chemical or special waste according to the regulations applying at the location of the user. It must never be thrown out with the general or domestic waste.

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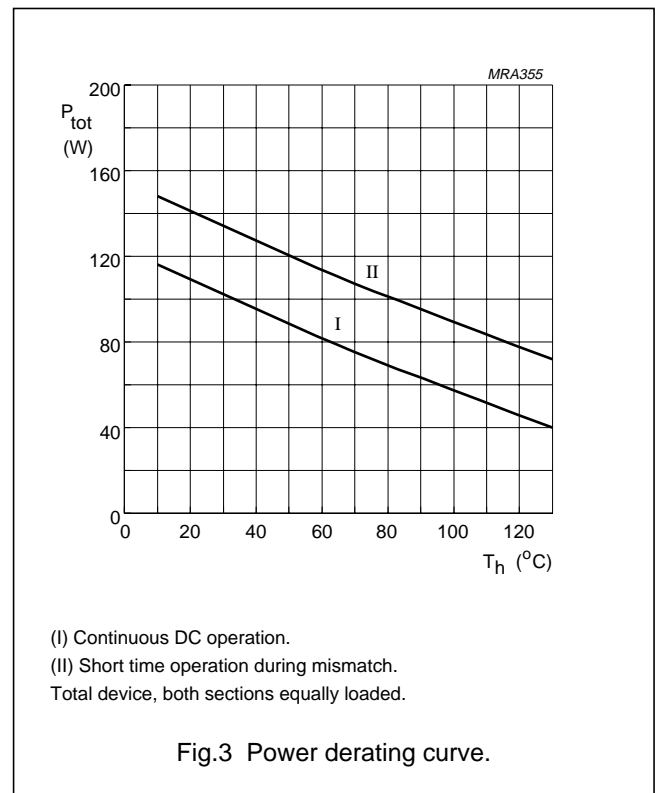
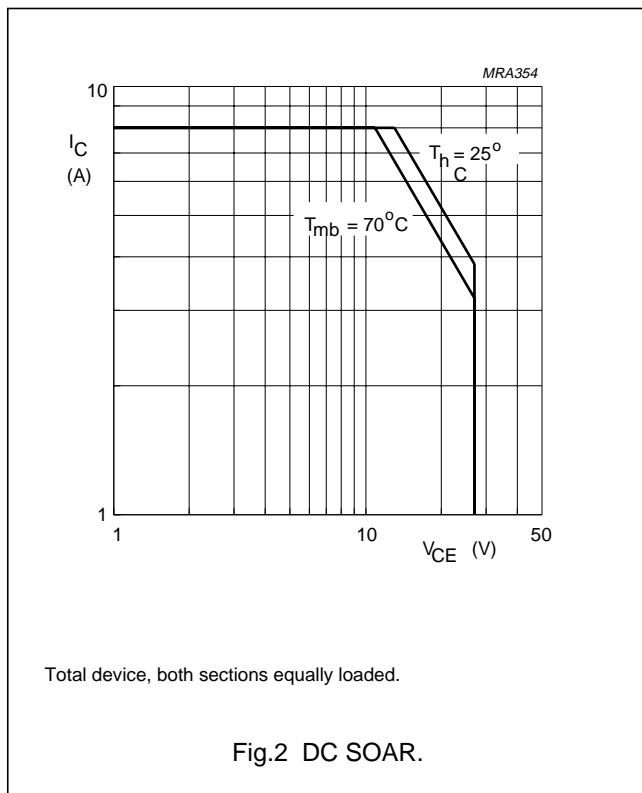
LIMITING VALUES (per transistor section unless otherwise specified)

In accordance with the Absolute Maximum System (IEC 134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V_{CBO}	collector-base voltage	open emitter	–	50	V
V_{CEO}	collector-emitter voltage	open base	–	27	V
V_{EBO}	emitter-base voltage	open collector	–	3.5	V
$I_C, I_{C(AV)}$	collector current	DC or average value	–	4	A
I_{CM}	collector current	peak value; $f > 1$ MHz	–	8	A
P_{tot}	total power dissipation	DC operation; $T_{mb} = 70^\circ\text{C}$ (note 1)	–	87	W
T_{stg}	storage temperature range		–65	150	$^\circ\text{C}$
T_j	junction operating temperature		–	200	$^\circ\text{C}$

Note

1. Total device, both sections equally loaded.



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THERMAL RESISTANCE

SYMBOL	PARAMETER	CONDITIONS	MAX.	UNIT
$R_{th\ j-mb(DC)}$	from junction to mounting base	$P_{dis} = 87\ W$; $T_{mb} = 70\ ^\circ C$ (note 1)	1.5	K/W
$R_{th\ mb-h}$	from mounting base to heatsink	note 1	0.2	K/W

Note

1. Total device, both sections equally loaded.

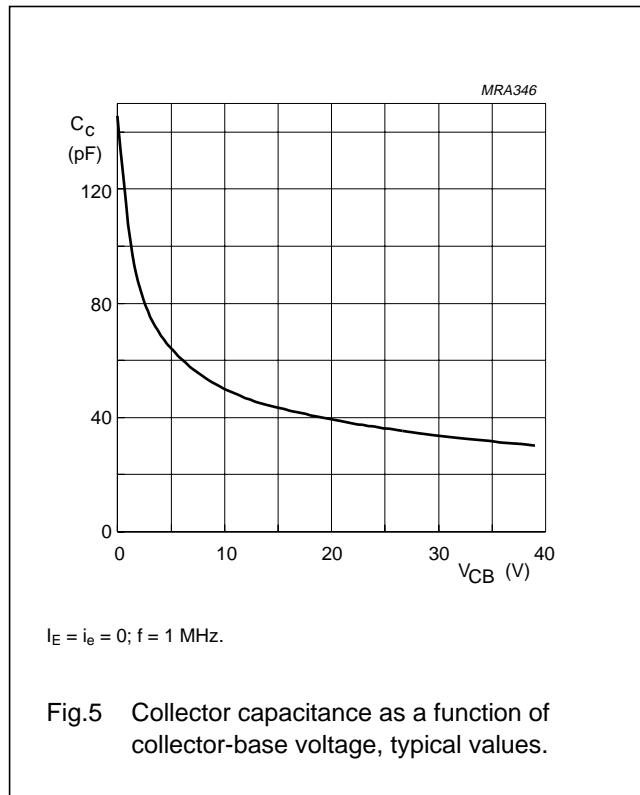
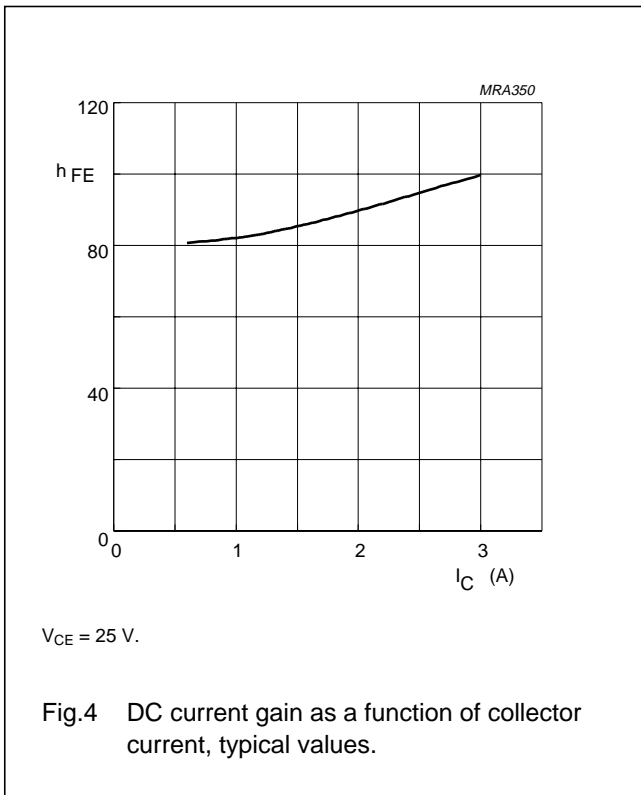
CHARACTERISTICS

Values apply to either transistor section; $T_j = 25\ ^\circ C$.

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
$V_{(BR)CBO}$	collector-base breakdown voltage	open emitter; $I_C = 20\ mA$	50	–	–	V
$V_{(BR)CEO}$	collector-emitter breakdown voltage	open base; $I_C = 50\ mA$	27	–	–	V
$V_{(BR)EBO}$	emitter-base breakdown voltage	open collector; $I_E = 10\ mA$	3.5	–	–	V
I_{CES}	collector-emitter leakage current	$V_{BE} = 0$; $V_{CE} = 27\ V$	–	–	10	mA
h_{FE}	DC current gain	$V_{CE} = 25\ V$; $I_C = 1.6\ A$	30	–	–	
C_c	collector capacitance	$V_{CB} = 25\ V$; $I_E = I_e = 0$; $f = 1\ MHz$	–	36	45	pF

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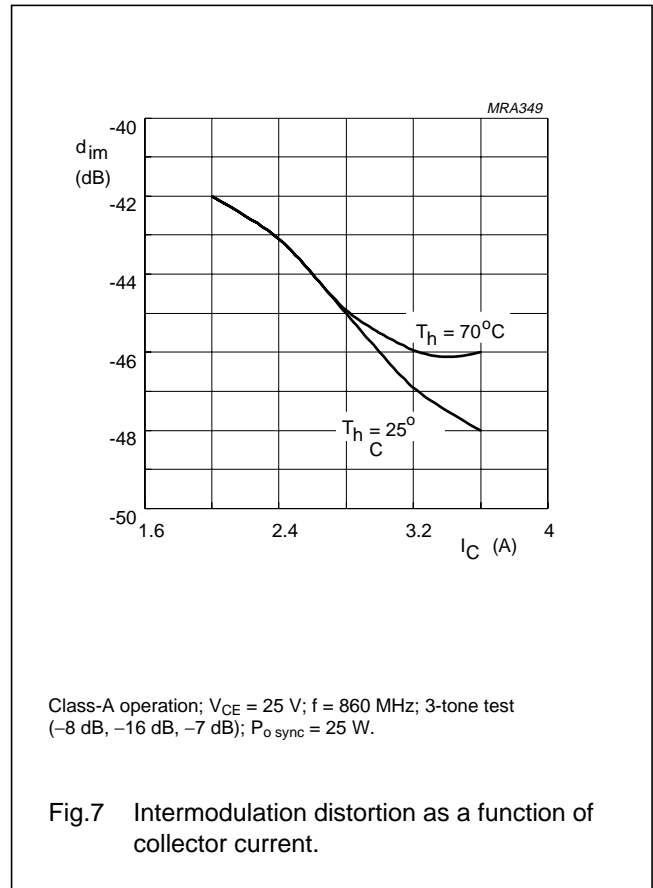
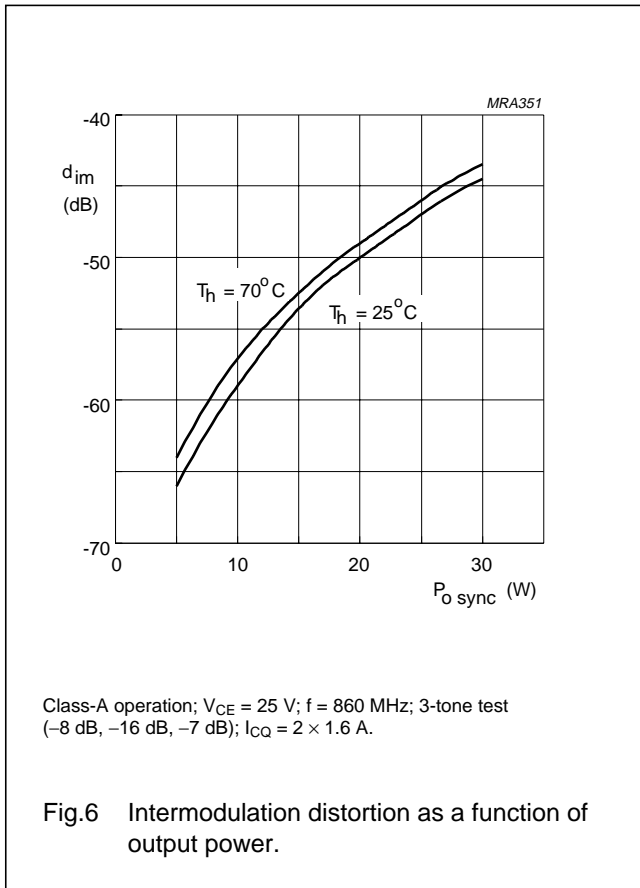
APPLICATION INFORMATION

RF performance at $T_h = 25\text{ }^\circ\text{C}$ in a common emitter push-pull test circuit; $R_{th\text{ mb-h}} = 0.2\text{ K/W}$.

MODE OF OPERATION	f_{vision} (MHz)	V_{CE} (V)	I_{CQ} (A)	$P_{\text{O sync}}$ (W)	G_P (dB)	d_{im} (dB) (note 1)	d_{cm} (%) (note 2)
c.w. class-A	860	25	2×1.6	25	> 10 typ. 11.5	< -45 typ. -47	< 20

Notes

1. Three-tone test method: vision carrier -8 dB (860 MHz), sound carrier -7 dB (865.5 MHz), sideband signal -16 dB (861 MHz); zero dB corresponds to peak sync level.
2. Two-tone test method: vision carrier 0 dB (860 MHz), sound carrier -7 dB (865.5 MHz); zero dB corresponds to peak sync level. Cross-modulation distortion (d_{cm}) is the voltage variation (%) of the sound carrier when the vision carrier is switched from 0 dB to -20 dB.



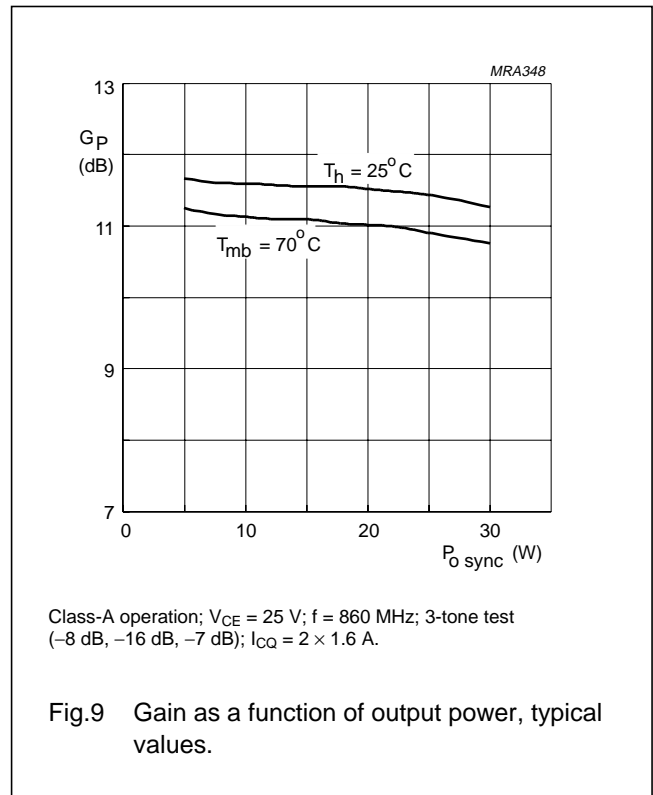
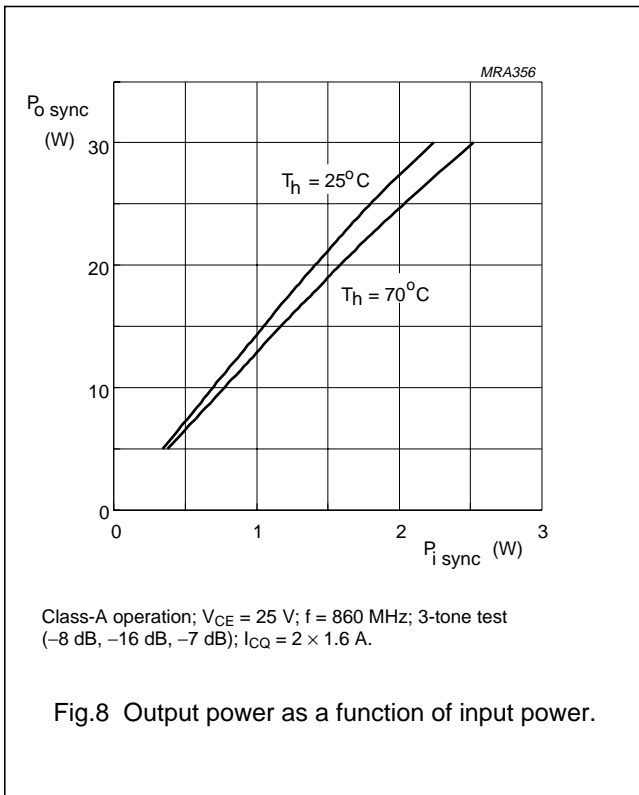
Ruggedness in Class-A operation

The BLV58 is capable of withstanding a full load mismatch corresponding to $V_{\text{SWR}} = 50:1$ through all phases under the following conditions:

$V_{\text{CE}} = 25\text{ V}$, $f = 860\text{ MHz}$, $T_h = 25\text{ }^\circ\text{C}$,
 $R_{th\text{ mb-h}} = 0.2\text{ K/W}$, $I_{\text{CQ}} = 2 \times 1.6\text{ A}$,
 and rated output power.

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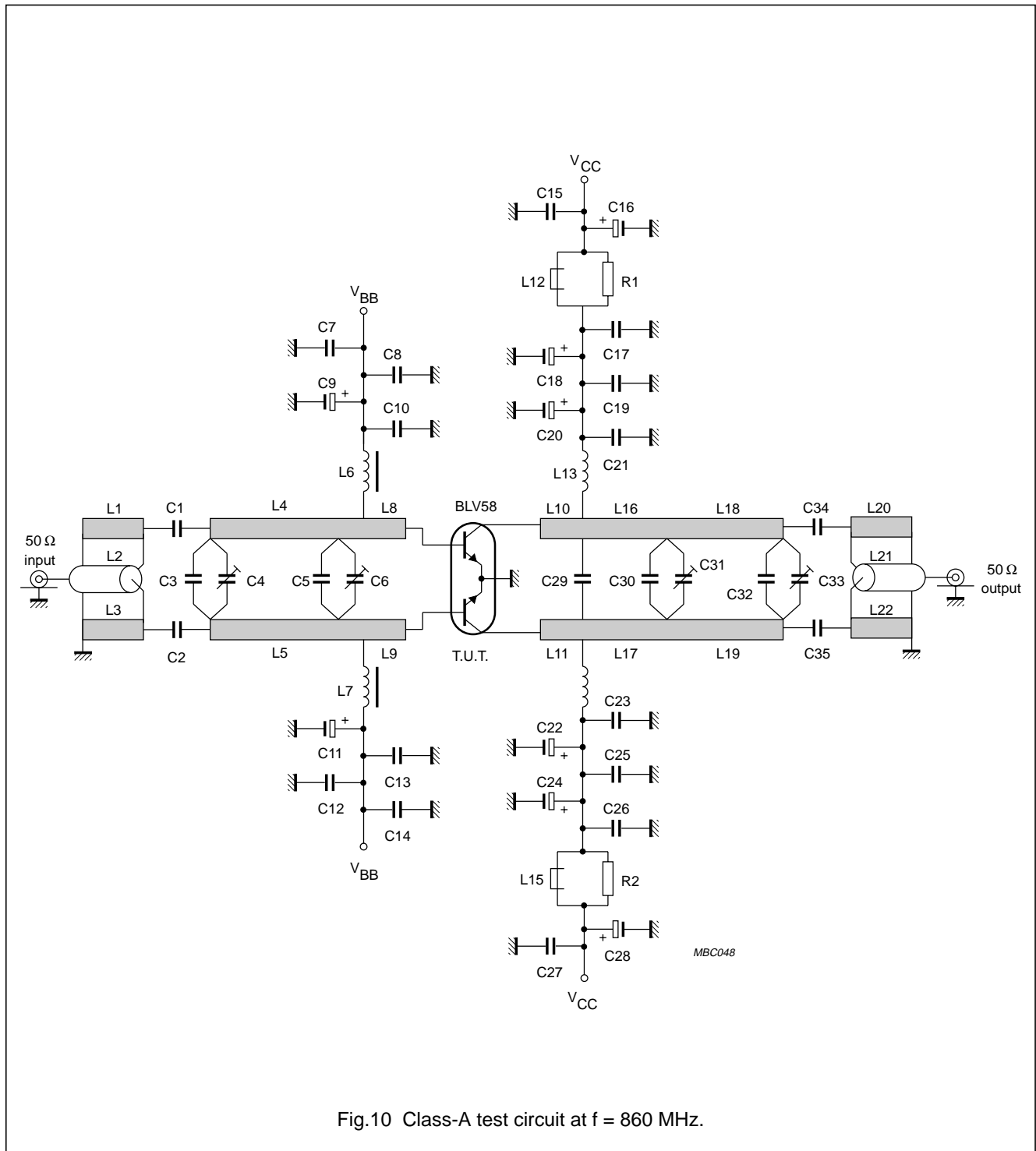


Fig.10 Class-A test circuit at $f = 860$ MHz.

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List of components (see test circuit)

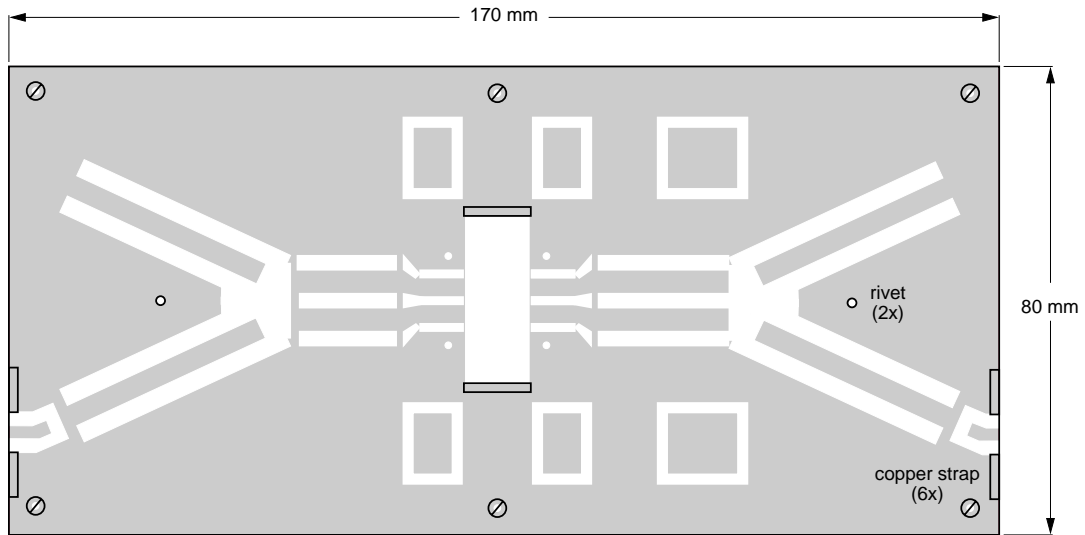
COMPONENT	DESCRIPTION	VALUE	DIMENSIONS	CATALOGUE NO.
C1, C2, C34, C35	multilayer ceramic chip capacitor (note 1)	15 pF		
C3	multilayer ceramic chip capacitor (note 1)	3.9 pF		
C4, C6	film dielectric trimmer	5.5 pF		2222 809 09005
C5	multilayer ceramic chip capacitor (note 1)	7.5 pF		
C7, C12, C17, C26	multilayer ceramic chip capacitor	10 nF		2222 852 47103
C8, C14, C19, C25	multilayer ceramic chip capacitor	100 nF		2222 852 47104
C9, C11, C16, C20, C22, C28	63 V electrolytic capacitor	10 μ F		
C10, C13, C15, C21, C23, C27	multilayer ceramic chip capacitor (note 1)	330 pF		
C18, C24	63 V electrolytic capacitor	1 μ F		
C29	multilayer ceramic chip capacitor (note 1)	12 pF		
C30	multilayer ceramic chip capacitor (note 1)	5.6 pF		
C31, C33	film dielectric trimmer	3.5 pF		2222 809 05001
C32	multilayer ceramic chip capacitor (note 1)	2.7 pF		
L1, L3, L20, L22	stripline (note 2)	35 Ω	39 mm \times 4 mm	
L2, L21	semi-rigid cable (note 3)	50 Ω	ext. dia. 3.6 mm; length 39 mm	
L4, L5	stripline (note 2)	38 Ω	19 mm \times 3.5 mm	
L6, L7	RF choke	470 nH		
L8, L9	stripline (note 2)	38 Ω	7.5 mm \times 3.5 mm	
L10, L11	stripline (note 2)	38 Ω	4.5 mm \times 3.5 mm	
L12, L15	grade 3B RF choke			4312 020 36642
L13, L14	1 turn 1.5 mm copper wire	14 nH	int. dia 7 mm; leads 2 \times 6 mm	
L16, L17	stripline (note 2)	38 Ω	7 mm \times 3.5 mm	
L18, L19	stripline (note 2)	38 Ω	18 mm \times 3.5 mm	
R1, R2	1 W metal film resistor	10 Ω		

Notes

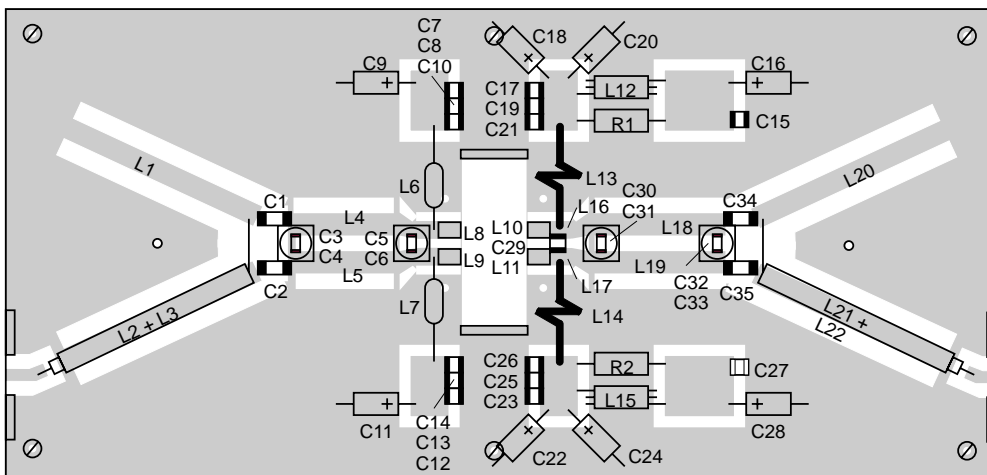
- American Technical Ceramics type 100B or capacitor of the same quality.
- The striplines are on a double copper-clad printed circuit board, with PTFE microfibre-glass dielectric ($\epsilon_r = 2.2$), thickness $\frac{1}{32}$ inch, thickness of copper sheet $2 \times 35 \mu\text{m}$.
- Cables L2 and L21 are soldered to striplines L1 and L20, respectively.

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MBC046



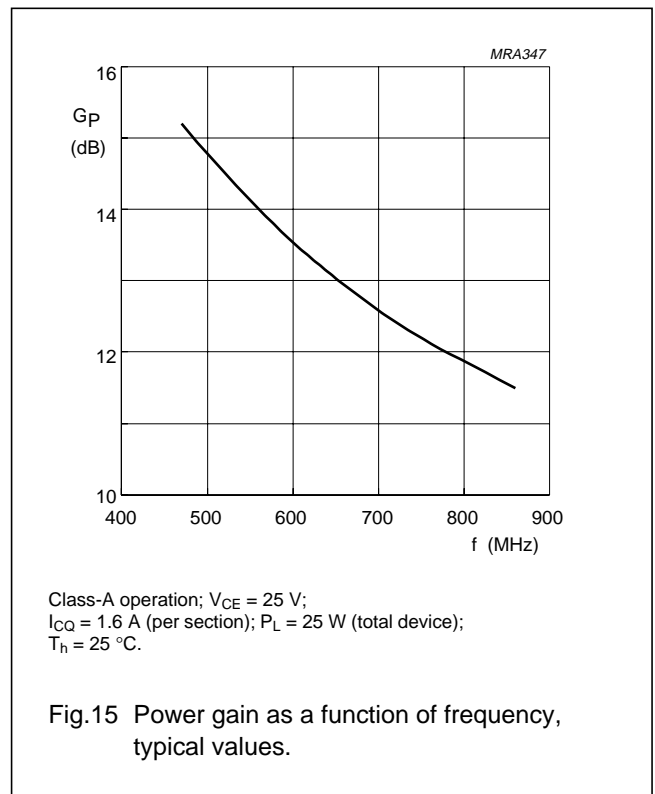
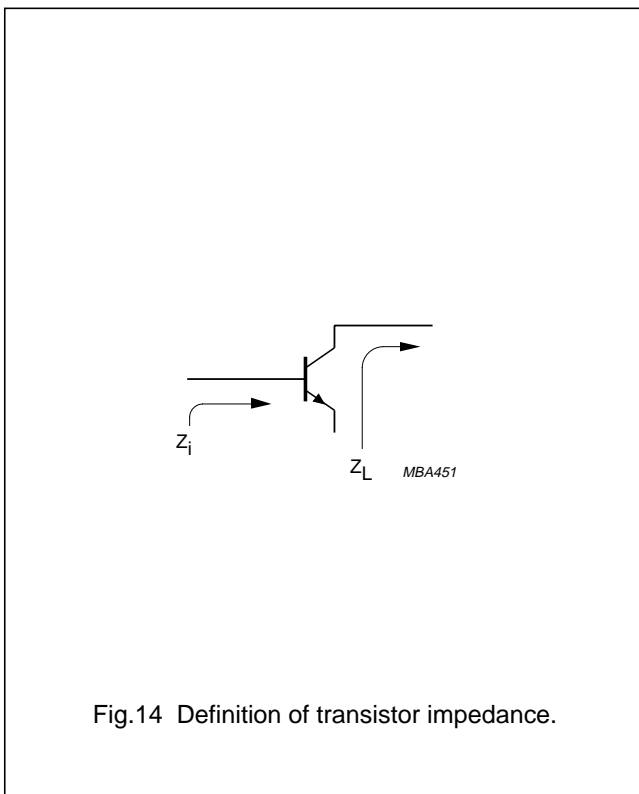
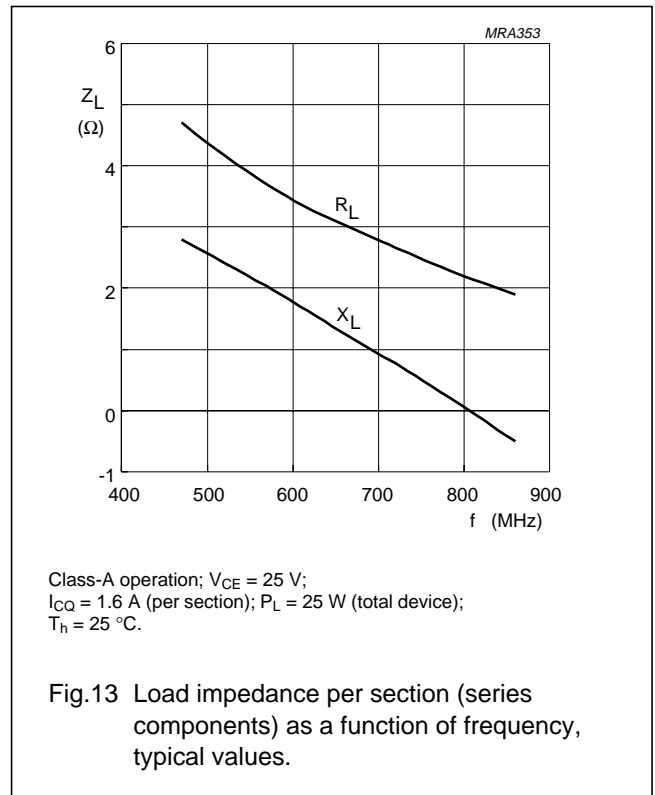
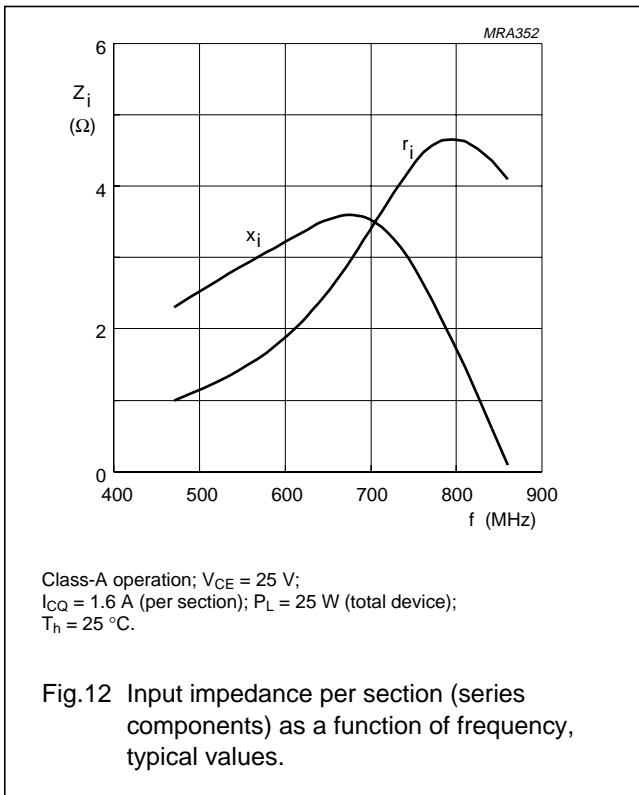
MBC047

The components are mounted on one side of a copper clad PTFE microfibre-glass board; the other side is unetched and serves as a ground plane. Earth connections from the component side to the ground plane are made by hollow rivets and copper straps.

Fig.11 Component layout for 860 MHz class-A test circuit.

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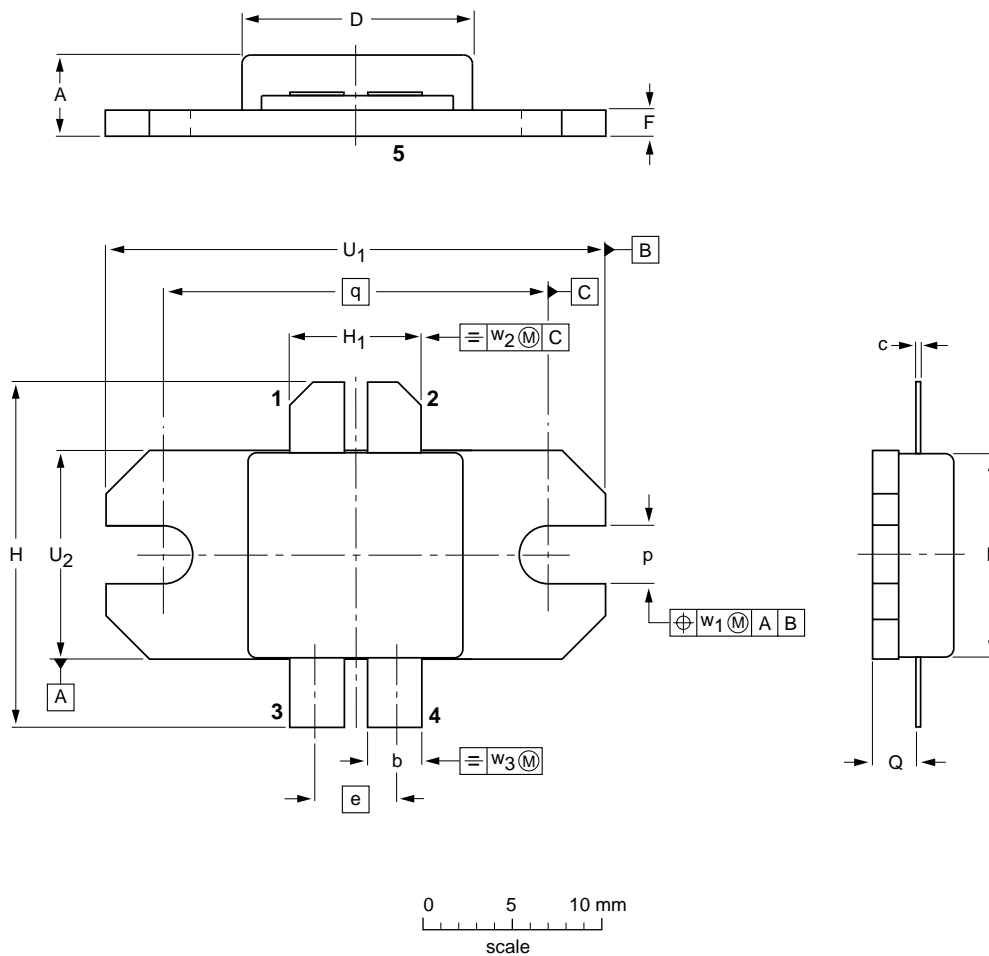
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PACKAGE OUTLINE

Flanged ceramic package; 2 mounting holes; 4 leads

SOT289A



DIMENSIONS (millimetre dimensions are derived from the original inch dimensions)

UNIT	A	b	c	D	E	e	F	H	H ₁	p	Q	q	U ₁	U ₂	w ₁	w ₂	w ₃
mm	4.65 3.92	3.33 3.07	0.10 0.05	13.10 12.90	11.53 11.33	4.60	1.65 1.40	19.81 19.05	4.85 4.34	3.43 3.17	2.31 2.06	21.44	28.07 27.81	11.81 11.56	0.51	1.02	0.25
inches	0.183 0.154	0.131 0.121	0.004 0.002	0.516 0.508	0.454 0.446	0.181	0.065 0.055	0.780 0.750	0.191 0.171	0.135 0.125	0.091 0.081	0.844	1.105 1.095	0.465 0.455	0.02	0.04	0.01

OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	EIAJ			
SOT289A						97-06-28

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DEFINITIONS

Data Sheet Status	
Objective specification	This data sheet contains target or goal specifications for product development.
Preliminary specification	This data sheet contains preliminary data; supplementary data may be published later.
Product specification	This data sheet contains final product specifications.
Limiting values	
Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.	
Application information	
Where application information is given, it is advisory and does not form part of the specification.	

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